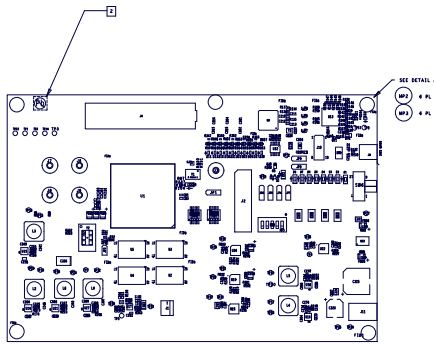
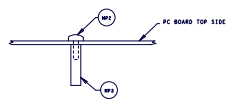


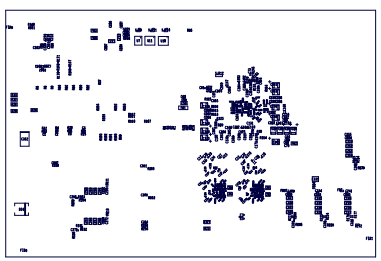
THIS DRAWING IS INTENDED TO HELP IN THE ASSEMBLY OF THE DESIGN.

- 1. REFER TO ODB++ FILE FOR SPECIFIC COMPONENT LOCATION INFORMATION.
- 2. FINISHED ASSEMBLY MUST BE RoHS COMPLIANT. LABEL OR MARK 'Pb FREE' IN THIS AREA ON TOP SIDE.

REVISIONS			
ZONE	LTR	DESCRIPTION	DATE APPROVED



TOP SIDE



BOTTOM SIDE

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES ARE: FRACTIONS DECIMALS ANGLES +/- .XX +/- .01 +/- -XXX +/- .005 +/-	CONTRACT NO.		TEXAS INSTRUMENTS INC.			
	APPROVALS	DATE				
MATERIAL SEE NOTE 5	DRAWN L. MURPHY 08-02-12		ASSEMBLY DRAWING TSM14J56 EVM			
FINISH SEE NOTES 7, 8, 9	ENGR J. KETON/EE DRAWING		SIZE B	CODE IDENT NO.	DRAWING NO.	REV. B
DO NOT SCALE DRAWING			SCALE NONE	SHEET 1 OF 1		

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